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Vishay Siliconix



Top View

Bottom View

PRODUCT SUMMARY	
V _{DS} (V)	30
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.00080
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.00115
Q _g typ. (nC)	48
I _D (A)	100 ^{a, g}
Configuration	Single

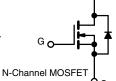
FEATURES

N-Channel 30 V (D-S) MOSFET

- TrenchFET[®] Gen IV power MOSFET
- Optimized $\mathsf{Q}_g,\,\mathsf{Q}_{gd},\,\text{and}\,\,\mathsf{Q}_{gd}/\mathsf{Q}_{gs}$ ratio reduces switching related power loss
- · Top side cooling feature provides additional venue for thermal transfer
- 100 % R_a and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Synchronous rectification
- High power density DC/DC
- Synchronous buck converter
- OR-ing
- Load switching
- Battery management



D

ORDERING INFORMATION	
Package	PowerPAK SO-8DC
Lead (Pb)-free and halogen-free	SiDR390DP-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	30	V	
Gate-source voltage		V _{GS}	+20 / -16	V	
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		100 ^a		
	T _C = 70 °C	Ι. Γ	100 ^a		
	T _A = 25 °C	I _D	69.9 ^{b, c}		
	T _A = 70 °C		55.9 ^{b, c}		
Pulsed drain current (t = 100 µs)		I _{DM}	400	— A	
Continuous source-drain diode current	T _C = 25 °C		100		
	T _A = 25 °C	I _S	5.6 ^{b, c}		
Single pulse avalanche current		I _{AS}	40		
Single pulse avalanche energy L = 0.1 mH		E _{AS}	80	mJ	
	T _C = 25 °C		125		
Maximum power dissipation	T _C = 70 °C		80	14/	
	T _A = 25 °C	P _D —	6.25 ^{b, c}	W	
	T _A = 70 °C		4 ^{b, c}		
Operating junction and storage temperature	range	T _J , T _{stg}	-55 to +150	•••	
Soldering recommendations (peak temperature) ^c			260	°C	

THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient ^b	t ≤ 10 s	R _{thJA}	15	20	
Maximum junction-to-case (drain)	Steady state	R _{thJC}	0.8	1	°C/W
Maximum junction-to-case (source)	Steady state	R _{thJC}	1.1	1.4	

Notes

a. Package limited

b. Surface mounted on 1" x 1" FR4 board

t = 10 s c.

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8DC is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

Rework conditions: manual soldering with a soldering iron is not recommended for leadless components e.

f. Maximum under steady state conditions is 54 °C/W

T_C = 25 °C g.

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SiDR390DP Vishay Siliconix

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static			•	•		
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	30	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$		-	17.5	-	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-6.3	-	mV/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	0.8	-	2	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = +20, -16 V$	-	-	± 100	nA
Zara gata valtaga drain aurrant	la sa	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	
Zero gate voltage drain current	IDSS	V_{DS} = 30 V, V_{GS} = 0 V, T_{J} = 55 °C	-	-	10	μA
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	50	-	-	А
Drain aquiras on state registence a	Б	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	0.00065	0.00080	Ω
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 15 \text{ A}$	-	0.00090	0.00115	52
Forward transconductance ^a	9 _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	110	-	S
Dynamic ^b						
Input capacitance	C _{iss}		-	10 180	-	
Output capacitance	C _{oss}		-	3290	-	pF
Reverse transfer capacitance	C _{rss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	-	306	-	
C _{rss} /C _{iss} ratio			-	0.031	0.062	
	0	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	-	102	153	
Total gate charge	Qg		-	48	72	l
Gate-source charge	Q _{gs}	V_{DS} = 15 V, V_{GS} = 4.5 V, I_{D} = 20 A	-	22	-	nC
Gate-drain charge	Q _{gd}		-	4.7	-	l
Output charge	Q _{oss}	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	105	-	l
Gate resistance	Rg	f = 1 MHz	0.5	1.3	2.5	Ω
Turn-on delay time	t _{d(on)}		-	15	30	
Rise time	t _r	V_{DD} = 15 V, R_L = 0.75 Ω	-	16	32	1
Turn-off delay time	t _{d(off)}	$I_D \cong$ 20 A, V_{GEN} = 10 V, R_g = 1 Ω	-	46	90	1
Fall time	t _f		-	10	20	1
Turn-on delay time	t _{d(on)}		-	51	100	ns
Rise time	t _r	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{L}} = 0.75 \Omega$	-	63	120	1
Turn-off delay time	t _{d(off)}	$I_D \cong 20$ A, $V_{GEN} = 4.5$ V, $R_g = 1$ Ω	-	78	155	l
Fall time	t _f		-	27	34	l
Drain-Source Body Diode Characteristic	s		•	•		
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	100	
Pulse diode forward current ($t_p = 100 \ \mu s$)	I _{SM}		-	-	400	A
Body diode voltage	V _{SD}	I _S = 10 A	-	0.68	1.1	V
Body diode reverse recovery time	t _{rr}		-	68	135	ns
Body diode reverse recovery charge	Q _{rr}	I _F = 20 A, di/dt = 100 A/μs,	-	98	180	nC
Body didde reverse recovery fall time t_a $I_F = 20 \text{ A}, di/dt = 100 \text{ A/µs},$ $ 36$ Reverse recovery fall time t_a $T_J = 25 \text{ °C}$ $ 29$		-				
Reverse recovery rise time	t _b		-	39	_	ns

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

b. Guaranteed by design, not subject to production testing

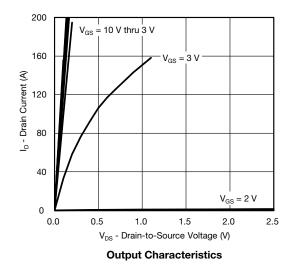
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

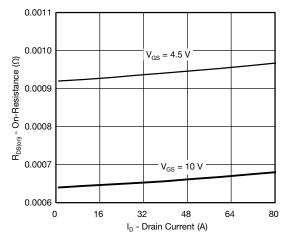
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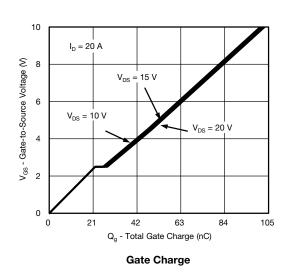
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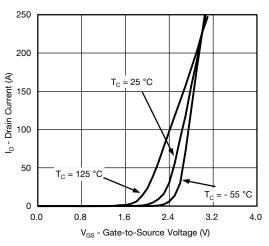
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



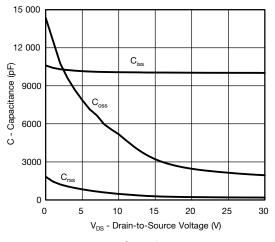


On-Resistance vs. Drain Current and Gate Voltage

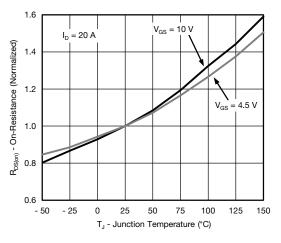




Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

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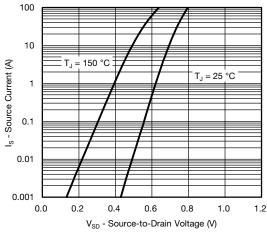
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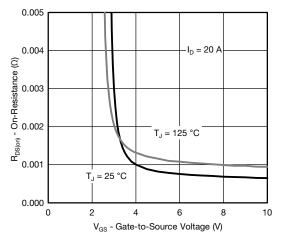


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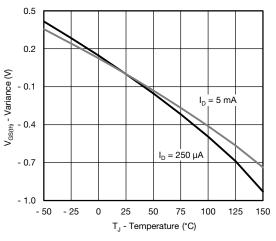
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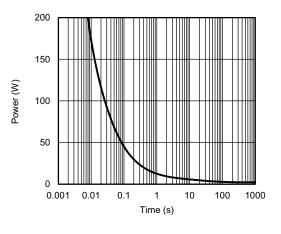
Source-Drain Diode Forward Voltage



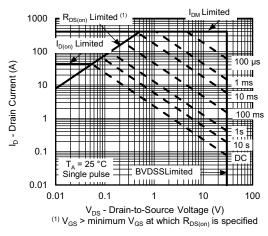
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

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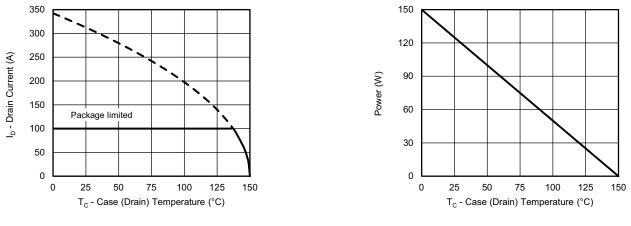
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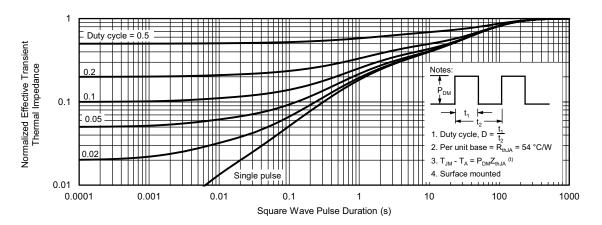


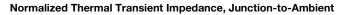
Current Derating ^a

Power, Junction-to-Case

Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

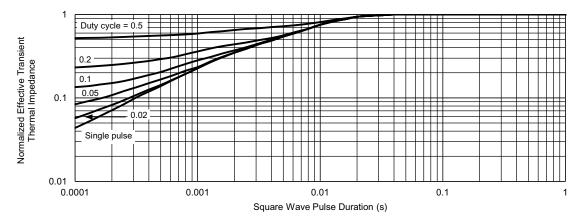




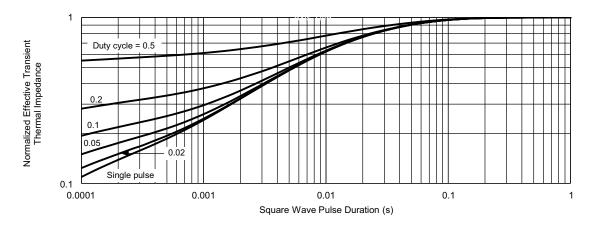


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case (Drain)



Normalized Thermal Transient Impedance, Junction-to-Case (Source)

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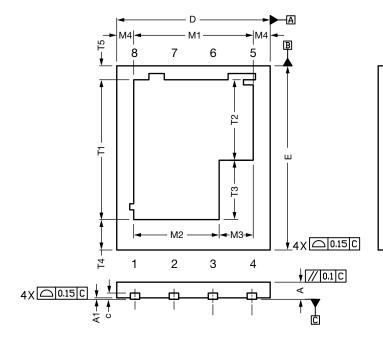
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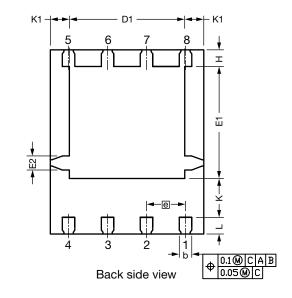


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PowerPAK[®] SO-8 Double Cooling Case Outline

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DIM.	MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.51	0.56	0.61	0.020	0.022	0.024	
A1	0.00	0.02	0.05	0.000	0.001	0.002	
b	0.36	0.41	0.46	0.014	0.016	0.018	
С	0.15	0.20	0.25	0.006	0.008	0.010	
D	4.90	5.00	5.10	0.193	0.197	0.201	
D1	3.71	3.76	3.81	0.146	0.148	0.150	
е		1.27 BSC			0.050 BSC		
E	5.90	6.00	6.10	0.232	0.236	0.240	
E1	3.60	3.65	3.70	0.142	0.144	0.146	
E2		0.46 typ.		0.018 typ.			
Н	0.49	0.54	0.59	0.019	0.021	0.023	
К	1.22	1.27	1.32	0.048	0.050	0.052	
K1		0.64 typ.		0.025 typ.			
L	0.49	0.54	0.59	0.019	0.021	0.023	
M1	3.85	3.90	3.95	0.152	0.154	0.156	
M2	2.74	2.79	2.84	0.108	0.110	0.112	
M3	1.06	1.11	1.16	0.042	0.044	0.046	
M4		0.56 typ.			0.022 typ.		
N		8		8			
T1	4.51	4.56	4.61	0.178	0.180	0.182	
T2	2.58	2.63	2.68	0.102	0.104	0.106	
Т3	1.88	1.93	1.98	0.074	0.076	0.078	
T4	0.97 typ.		0.038 typ.				
T5	0.48 typ.		0.019 typ.				
	ev. B, 08-Feb-2021						
G: 6048							

Revison: 08-Feb-2021

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Application Note 826

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RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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